

At page 2, line 5, please substitute "(see" with - See--.

At page 2, line 9, please delete "and" and insert --;-- after "(").

At page 2, lines 11-13, please delete ". [Presently the role of texture improvement is known for Al and Cu films]. The Cu reference is".

At page 2, line 11, please insert --;-- after "(").

At page 7, line 4, please substitute the phrase "to enhance the" with --with enhanced--.

In the claims

1. (twice amended) An integrated circuit comprising:
a dielectric layer formed over a substrate;
a damascene structure in the dielectric layer, the damascene structure comprising a bottom surface and first and second sidewalls;
a conductor located in the damascene structure, the conductor comprising a conductive material[s to form device interconnections, the conductor being formed from a damascene structure]; and
a liner layer [surrounding at least three surfaces of the conductor] lining the bottom surface and sidewalls of the damascene structure and contacts first, second, and third surfaces of the conductor, the liner layer imparts [imparting] a random grain orientation in the conductive material of the conductor to improve [electromagnetic] electromigration lifetime of the conductor.
2. (once amended) An integrated circuit of claim 1, wherein the conductive material of the liner comprises [material has] a random grain orientation.
3. (once amended) An integrated circuit of claim 1, wherein the conductive material of the liner comprises [material of] an amorphous character.
4. (once amended) An integrated circuit of claim 1, wherein the conductive material of the liner [comprises a material] is chosen from [of the] a group consisting essentially of titanium nitride, tantalum and tantalum nitride.